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### Systems and methods for deicing aircraft

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#### Abstract

An aircraft includes external structures, and one or more thermal emitters integrated with one or more of the external structures. The one or more thermal emitters are configured to generate heat to deice the one or more external structures. The one or more thermal emitters are configured to receive electrical power from one or more of an auxiliary power unit of the aircraft, a power distribution system of the aircraft, one or more engines of the aircraft, or an external power cart that is separate and distinct from the aircraft.

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## Background/Summary

### FIELD OF THE DISCLOSURE

(1) Examples of the present disclosure generally relate to systems and methods for deicing aircraft.

### BACKGROUND OF THE DISCLOSURE

(2) Aircraft are used to transport passengers and cargo between various locations. Numerous aircraft depart from and arrive at a typical airport every day.

(3) During periods of inclement weather, such as when the temperature is at or below freezing and precipitation is present, aircraft are often deiced before departing an airport. A known deicing process includes spraying exterior surfaces of an aircraft with chemicals, which typically includes some form of liquid antifreeze mixed with water, and heated to 180 degrees F. The aircraft is generally deiced before departure from an airport. However, the deicing process may not provide protection after the deicing liquid has been applied to the aircraft. For example, ice can build up on surfaces after the deicing process, and before takeoff. Additionally, the deicing process is time and labor intensive, as well as costly in terms of materials for the deicing liquid, as well as equipment used to apply the deicing liquid. Also, deicing liquid that flows off of the aircraft typically needs to be collected and properly disposed.

### SUMMARY OF THE DISCLOSURE

(4) A need exists for an improved system and method for deicing surfaces of an aircraft. Further, a need exists for an effective and efficient system and method for deicing surfaces of an aircraft. Also, a need exists for a cost-effective and environmentally friendly system and method for deicing surfaces of an aircraft.

(5) With those needs in mind, certain examples of the present disclosure provide an aircraft including external structures, and one or more thermal emitters integrated with one or more of the external structures. The one or more thermal emitters are configured to generate heat to deice the one or more external structures. The one or more thermal emitters are configured to receive electrical power from one or more of an auxiliary power unit of the aircraft, a power distribution

- system of the aircraft, one or more engines of the aircraft, an external power cart that is separate and distinct from the aircraft, one or more batteries, a power generator, and/or the like.
- (6) The external structures can include one or more of a fuselage, one or more wings, an empennage, a vertical stabilizer, a horizontal stabilizer, or control surfaces.
- (7) In at least one example, the one or more thermal emitters are integrated with all of the external structures.
- (8) In at least one example, the one or more thermal emitters are mounted to one or more exterior surfaces of the one or more external structures.
- (9) In at least one example, the one or more thermal emitters are embedded within the one or more external structures.
- (10) In at least one example, the one or more thermal emitters are formed of a metal matrix composite.
- (11) In at least one example, the one or more thermal emitters include one or more of wires, ribbons, tape, or strips.
- (12) In at least one example, the one or more thermal emitters cover less than an entirety of the one or more external structures.
- (13) In at least one example, the one or more thermal emitters include a plurality of segments spaced apart from one another in relation to the one or more external structures.
- (14) In at least one example, the one or more thermal emitters include a grid having a plurality of segments separated by open areas.
- (15) In at least one example, the one or more thermal emitters further provide electromagnetic effect protection to the one or more external structures without a separate current carrying path.
- (16) In at least one example, a control unit is configured to determine a configuration for the one or more thermal emitters based on a unit area that is representative of a portion of the one or more external structures. In at least one example, the control unit is configured to generate a one dimensional thermal resistance model to determine a temperature of an exposed outer mold line patch of the aircraft.
- (17) In at least one example, the one or more thermal emitters include a plurality of cells connected together in a tessellated pattern.
- (18) Certain examples of the present disclosure provide a method including integrating one or more thermal emitters with one or more of external structures of an aircraft; providing electrical power to the one or more thermal emitters by one or more of an auxiliary power unit of the aircraft, a power distribution system of the aircraft, one or more engines of the aircraft, an external power cart that is separate and distinct from the aircraft, one or more batteries, a power generator, and/or the like; and generating heat, by the one or more thermal emitters, to deice the one or more external structures.
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## **Description**

### **BRIEF DESCRIPTION OF THE DRAWINGS**

- (1) FIG. 1 illustrates a block diagram of an aircraft, according to an example of the present disclosure.
- (2) FIG. 2 illustrates a block diagram of power sources, according to an example of the present disclosure.
- (3) FIG. 3 illustrates a perspective front view of an aircraft, according to an example of the present disclosure.
- (4) FIG. 4 illustrates a top view of a unit area of a deicing system, according to an example of the present disclosure.
- (5) FIG. 5 illustrates a top view of a wing, according to an example of the present disclosure.
- (6) FIG. 6 illustrates a portion of the wing of FIG. 5.

- (7) FIG. 7 illustrates a top view of thermal emitters coupled to an external structure, according to an example of the present disclosure.
- (8) FIG. 8 illustrates a top view of an external structure having thermal emitters, according to an example of the present disclosure.
- (9) FIG. 9 illustrates a top view of an external structure having thermal emitters, according to an example of the present disclosure.
- (10) FIG. 10 illustrates a flow chart of a deicing method, according to an example of the present disclosure.

#### DETAILED DESCRIPTION OF THE DISCLOSURE

- (11) The foregoing summary, as well as the following detailed description of certain examples will be better understood when read in conjunction with the appended drawings. As used herein, an element or step recited in the singular and preceded by the word “a” or “an” should be understood as not necessarily excluding the plural of the elements or steps. Further, references to “one example” are not intended to be interpreted as excluding the existence of additional examples that also incorporate the recited features. Moreover, unless explicitly stated to the contrary, examples “comprising” or “having” an element or a plurality of elements having a particular condition can include additional elements not having that condition.
- (12) Certain examples of the present disclosure provide systems and methods for deicing portions of an aircraft. In at least one example, systems and methods are configured to enable an aircraft to self-deice while on the ground using thermal emitters applied to external structures of the aircraft. In at least one example, electrical power is provided to the thermal emitters through one or more of a power distribution system of the aircraft, an external power cart while the aircraft is stationary on the ground, and/or by auxiliary power unit or main engines while the aircraft is in motion (such as taxiing to a runway, or while airborne).
- (13) FIG. 1 illustrates a block diagram of an aircraft **100**, according to an example of the present disclosure. The aircraft **100** includes external structures **102**, such as a fuselage, wings, an empennage, a vertical stabilizer, a horizontal stabilizer, control surfaces (such as ailerons, flaps, etc.), and the like. One or more thermal emitters **104** are coupled to one or more of the external structures **102**. In at least one example, thermal emitters **104** are coupled to all of the external structures **102** of the aircraft **100**. In at least one other example, thermal emitters **104** are coupled to less than all of the external structures **102** of the aircraft **100**.
- (14) The thermal emitters **104** are integrated with the external structures **102**. For example, the thermal emitters **104** are mounted to exterior surfaces (for example, an outer mold line) of the external structures **102**. The thermal emitters **104** can be secured to the exterior surfaces of the external structures **102** through adhesives, fasteners, bonding, and/or the like. As another example, the thermal emitters **104** can be etched onto the exterior surfaces of the external structures **102**. As another example, the thermal emitters **104** are embedded within the external structures **102**. For example, the external structures **102** can be formed of composite materials, and the external structures **102** can be secured within one or more plies or layers of the external structures **102**. As another example, the thermal emitters **104** can be secured to internal surfaces (opposite from the exterior surfaces) of the external structures **102**, such as an interior wall of a fuselage.
- (15) The thermal emitters **104** are formed of a material that is configured to conduct, radiate, and/or otherwise emit heat when activated and connected to a power source **106**. For example, the thermal emitters **104** can be formed of one or more metals, such as copper, aluminum, steel, metallic alloys, and/or the like. As another example, the thermal emitters **104** can be formed of carbon. As another example, the thermal emitters can be formed of a metal matrix composite, such as a composite matrix having fibers or particles dispersed in a metallic matrix, such as copper, aluminum, steel, or the like. The thermal emitters **104** can be wires, ribbons, tape, strips, and/or the like. In at least one example, the thermal emitters have a width of 6 inches or less, and a thickness (for example, height) of 2 inches or less. Optionally, the thermal emitters can have a width greater than 6 inches,

and a thickness that is greater than 2 inches.

(16) In at least one example, the thermal emitters **104** include segments that cover less than an entirety of an external structure **102**. For example, the segments can be spaced between 4-6 inches from one another. By spacing portions of the thermal emitters **104** so that the entirety of the external structure **102** is not covered, less material is used, and the weight of the aircraft is reduced. Alternatively, an entirety of the external structure **102** may be covered by the thermal emitters **104**.

(17) The thermal emitters **104** are coupled to the power source **106** through one or more wired or wireless connections. In operation, the thermal emitters **104** can be activated, such as by a pilot within a flight deck. When activated, the thermal emitters **104** draw power from the power source **106** and generate heat to melt ice on the external structures **102** and/or prevent ice from forming thereon. The thermal emitters **104** deice the external structures **102** without the need for a separate and distinct deicing liquid. Further, the thermal emitters **104** can be operated to deice the external structures **102** when the aircraft **100** is parked at a gate, moving along a taxiway or runway, and/or while airborne.

(18) FIG. 2 illustrates a block diagram of power sources **106**, according to an example of the present disclosure. Examples of power sources **106** include an auxiliary power unit **106a** of the aircraft **100** (shown in FIG. 1), a power distribution system **106b** of the aircraft **100**, an external power cart **106c** that is separate and distinct from the aircraft **100**, one or more engines **106d** of the aircraft **100**, one or more batteries **106e**, a power generator, one or more solar cells, one or more wind turbines, and or the like. Referring to FIGS. 1 and 2, the thermal emitters **104** can be electrically powered by the auxiliary power unit **106a** of the aircraft **100**, the power distribution system **106b** of the aircraft **100**, the engines **106d** of the aircraft **100** (such as when the aircraft **100** is in motion), and/or the external power cart **106c** (such as when the aircraft **100** is stationary).

(19) The external structures **102** can be formed of one or more composite materials, one or more metals, and/or the like. The thermal emitters **104** are coupled to the external structures **102** (for example, secured directly onto exterior surfaces and/or embedded therein). When activated, the thermal emitters **104** conduct heat, thereby melting any ice that has accumulated on the external structures **102** and preventing ice from forming thereon. As such, the external structures **102** of the aircraft **100** can be deiced while the aircraft **100** is stationary, moving on the ground, and/or airborne.

(20) The thermal emitters **104** are coupled to the external structures **102** to provide sufficient heat to deice the external surfaces of the external structures **102**. In at least one example, a geometry model for the thermal emitters is optimized to maximize or otherwise increase a deicing rate, using a grid pattern that is less than an entire external surface to reduce weight. For example, the thermal emitters **104** can be configured as a continuous grid on and/or within the external structures **102**. As another example, the thermal emitters **104** can be configured to include a main power trace coupled to branching segments (for example, traces), which can be electrically connected in parallel. Spacing between the segments can be based on curvature of the external structures **102** (such as wings).

(21) In at least one example, the thermal emitters **104** include segments (for example, traces) that are cut or deposited onto the external structures **102**. The segments are spaced apart from one another to provide desired heating to the external structures **102**. In at least one example, the thermal emitters **104** can also provide electromagnetic effect protection to the external structures **102** as a secondary function by providing a current carrying path. Known aircraft have copper foil as a current carrying path to accept electric charge and convey current so it can be bled off plane. The thermal emitters **104** can therefore also be used to perform such current carrying paths, and therefore the copper foil material can be removed, thereby reducing overall weight of the aircraft **100**. In at least one example, the segments of the thermal emitters **104** can run under fasteners, thereby providing an integrated current return path.

(22) As described herein, the aircraft **100** includes the external structures **102**. One or more thermal

emitters **104** are integrated with one or more of the external structures **102**. The one or more thermal emitters **104** are configured to generate heat to deice the one or more external structures **102**. The one or more thermal emitters **104** are configured to receive electrical power from one or more of the auxiliary power unit **106a** of the aircraft **100**, the power distribution system **106b** of the aircraft **100**, one or more engines **106d** of the aircraft **100**, or the external power cart **106c** that is separate and distinct from the aircraft **100**.

(23) FIG. 3 illustrates a perspective front view of an aircraft **100**, according to an example of the present disclosure. The aircraft **100** includes a propulsion system **112** that includes engines **114**, for example. Optionally, the propulsion system **112** may include more engines **114** than shown. The engines **114** are carried by wings **116** of the aircraft **100**. In other examples, the engines **114** may be carried by a fuselage **118** and/or an empennage **120**. The empennage **120** may also support horizontal stabilizers **122** and a vertical stabilizer **124**. The fuselage **118** of the aircraft **100** defines an internal cabin **130**, which includes a flight deck or cockpit, one or more work sections (for example, galleys, personnel carry-on baggage areas, and the like), one or more passenger sections (for example, first class, business class, and coach sections), one or more lavatories, and/or the like. FIG. 3 shows an example of an aircraft **100**. It is to be understood that the aircraft **100** can be sized, shaped, and configured differently than shown in FIG. 3.

(24) Thermal emitters **104** are coupled to one or more external structures of the aircraft **100**. For example, thermal emitters **104** are coupled to the wings **116**, the fuselage **118**, the empennage **120**, the horizontal stabilizers **122**, the vertical stabilizer **124**, and/or the like.

(25) Referring to FIGS. 1-3, in at least one example, the thermal emitters **104** are formed of a metal matrix composite. The thermal emitters **104** are configured to emit conductive heat energy used to heat an outer mold line of a wing **116** to a desired temperature, melt any ice accumulated thereon, and prevent ice from forming thereon.

(26) FIG. 4 illustrates a top view of a unit area **140** of a deicing system **142**, according to an example of the present disclosure. Referring to FIGS. 1 and 4, a control unit **150** generates a unit representation (that is, the unit area **140**) of the deicing system **142**. The unit area **140** is a one dimensional thermal resistance model such that the temperature of an exposed outer mold line patch, some distance away from a thermal emitter **104**, can be determined. In at least one example, the control unit **150** simplifies an overall deicing system, through creation of the unit area **140**, which can have dimensions of a metal matrix composite width and thickness, and exposed length in relation to an outer mold line.

(27) The unit area **140** includes a thermal emitter **104** including a plurality of segments over a portion of an external structure **102**. For example, horizontal segments (for example, traces) **144** are spaced apart from one another by vertical segments (for example, traces) **146**, which are orthogonal to the horizontal segments **146**. The control unit **150** is configured to determine the spacing between the segments (such as the spacing provided by the vertical segments **146**) so that the thermal emitter **104** provides sufficient deicing heat (that is, sufficient heat to melt ice and prevent ice from forming) to the portion of the external structure **102** within a predetermined desired time.

(28) In at least one example, the control unit **150** is configured to determine a configuration for a thermal emitter **104** in relation to an external structure **102**, such as a wing, through analysis of the unit area **140**, which is a representative portion of the external structure **102**, such as a 1 foot by 1 foot portion of the external structure **102**. The control unit **150** determines the desired heat to apply for deicing in relation to the unit area **140**, which is then used to determine the configuration for the thermal emitter in relation to an entirety of the external structure **102**. In this manner, the control unit **150** simplifies and process of determining the configuration for the thermal emitter **104** by analyzing a much smaller portion, and thereby conserving computing power.

(29) In at least one example, the control unit **150** is configured to optimize the thermal emission circuit geometry and power requirements of a deicing system for use in relation to external

structures **102** of an aircraft **100**. The control unit **150** creates the unit area **140**, which is a representation of a portion of the deicing system **142**. The control unit **150** further generates a one dimensional thermal resistance model such that the temperature of an exposed outer mold line patch of the aircraft **100**, which is a predetermined distance away from segments of the thermal emitter **104**, is determined.

(30) FIG. 5 illustrates a top view of a wing **116**, according to an example of the present disclosure. FIG. 6 illustrates a portion of the wing **116** of FIG. 5. Referring to FIGS. 1-6, the wing **116** is an example of an external structure **102** (shown in FIG. 1). A thermal emitter **104** is coupled to the wing **116**. For example, the thermal emitter **104** is mounted on an exterior surface of the wing **116**. As another example, the thermal emitter **104** is embedded within the wing **116**.

(31) The thermal emitter **104** includes a main power trace **160**, which can be directly connected to the power source **106**. The main power trace **160** connects to lateral segments **162** and **164**, such as at a front and rear of the wing **116**, respectively. The lateral segments **162** and **164** connect to interior longitudinal segments **166**, which are spaced apart from one another. The configuration shown in FIGS. 5 and 6 is merely exemplary, and is not to scale. The spacing between the lateral segments **162** and **164** and the longitudinal segments **166** can be based on curvature of the wing **116**.

(32) The main power trace **160**, the lateral segments **162** and **164**, and the longitudinal segments **166** provide a grid **167** having open areas **169** between the lateral segments **162**, **164**, and longitudinal segments **166**. As such, the grid **167** does not cover an entirety of the external structure, such as the wing **116**. As such, the grid **167** includes a plurality of open areas **169** therein. The open areas **169** are locations of the external structure that are not covered by the thermal emitter **104**. The lateral segments **162** and **164** and the longitudinal segments **166** are configured to generate heat to deice the portions of the external structure within the open areas **169** in a predetermined period of time. Because the thermal emitter **104** includes the various open areas **169**, the thermal emitter **104** reduces an overall weight of the aircraft (in contrast to thermal emitters that cover an entirety of an external structure). As shown, one or more thermal emitters **104** include the grid **167** having a plurality of segments **162**, **164**, and **166** separated by open areas **169**.

(33) The control unit **150** is configured to determine a desired configuration, including the spacing between segments, of the thermal emitter **104**. For example, the control unit **150** can determine the configuration for the thermal emitter **104** based on a predetermined maximum service temperature, dimensions of the external structure **102** (such as the wing **116**), a minimum and/or maximum deicing time, required power, and the like. In at least one example, the control unit **150** performs a one dimensional analysis, which assumes no heat flux at boundaries of the wing **116** and/or the thermal emitter **104**, and no area gradient.

(34) In at least one example, the control unit **150** determines the configuration for the thermal emitter **104**, such as via the unit area **140** shown in FIG. 4, by referencing a predetermined heat necessary to create a layer of water under a stack of snow and ice. For example, specific heat to melt ice can be programmed into a memory of the control unit **150**. The control unit **150** then analyzes the mass of melting ice, and can assume a particular loss.

(35) In at least one example, the control unit **150** assumes full wing coverage of the thermal emitter **104**. For example, the control unit **150** assumes that the thermal emitter **104** covers an entirety of the wing **116**. The control unit **150** then determines an amount of energy needed to heat the wing **116**, via the thermal emitter **104**, to a desired set temperature. Next, the control unit **150** may assume a predetermined worst case scenario of accumulation of snow and ice on the wing **116**. The control unit **150** may then calculate the amount of energy need to heat the full coverage material to a predetermined set temperature, and the amount of energy needed to melt a layer of ice on the wing **116**. The control unit **150** may then conclude that most of the energy is directed into the phase change of ice into liquid water. However, as noted, in order to reduce weight, the thermal emitter **104** may not cover an entirety of the wing **116**.



(36) As such, the control unit **150** may then assume a patterned wing coverage of the thermal emitter **104**, such as shown in FIGS. **5** and **6**. The control unit **150** may then analyze the unit area **140**, shown in FIG. **4**, which includes a predetermined configuration for the thermal emitter **104**. The control unit **150** may then calculate the amount of energy needed to heat the thermal emitter **104** such that the temperature at the far end of the wing **116** will be at the predetermined temperature.

(37) FIG. **7** illustrates a top view of thermal emitters **104** coupled to an external structure, according to an example of the present disclosure. The thermal emitters **104** can include overlapping portions **105** and/or end-to-end welds **107**.

(38) As used herein, the term “control unit,” “central processing unit,” “CPU,” “computer,” or the like may include any processor-based or microprocessor-based system including systems using microcontrollers, reduced instruction set computers (RISC), application specific integrated circuits (ASICs), logic circuits, and any other circuit or processor including hardware, software, or a combination thereof capable of executing the functions described herein. Such are exemplary only, and are thus not intended to limit in any way the definition and/or meaning of such terms. For example, the control unit **150** can be or include one or more processors that are configured to control operation, as described herein.

(39) The control unit **150** is configured to execute a set of instructions that are stored in one or more data storage units or elements (such as one or more memories), in order to process data. For example, the control unit **150** can include or be coupled to one or more memories. The data storage units can also store data or other information as desired or needed. The data storage units can be in the form of an information source or a physical memory element within a processing machine.

(40) The set of instructions may include various commands that instruct the control unit **150** as a processing machine to perform specific operations such as the methods and processes of the various examples of the subject matter described herein. The set of instructions can be in the form of a software program. The software can be in various forms such as system software or application software. Further, the software can be in the form of a collection of separate programs, a program subset within a larger program, or a portion of a program. The software can also include modular programming in the form of object-oriented programming. The processing of input data by the processing machine may be in response to user commands, or in response to results of previous processing, or in response to a request made by another processing machine.

(41) The diagrams of examples herein illustrate one or more control or processing units, such as the control unit **150**. It is to be understood that the processing or control units can represent circuits, circuitry, or portions thereof that may be implemented as hardware with associated instructions (e.g., software stored on a tangible and non-transitory computer readable storage medium, such as a computer hard drive, ROM, RAM, or the like) that perform the operations described herein. The hardware can include state machine circuitry hardwired to perform the functions described herein. Optionally, the hardware can include electronic circuits that include and/or are connected to one or more logic-based devices, such as microprocessors, processors, controllers, or the like. Optionally, the control unit **150** can represent processing circuitry such as one or more of a field programmable gate array (FPGA), application specific integrated circuit (ASIC), microprocessor(s), and/or the like. The circuits in various examples may be configured to execute one or more algorithms to perform functions described herein. The one or more algorithms can include aspects of examples disclosed herein, whether or not expressly identified in a flowchart or a method.

(42) As used herein, the terms “software” and “firmware” are interchangeable, and include any computer program stored in a data storage unit (for example, one or more memories) for execution by a computer, including RAM memory, ROM memory, EPROM memory, EEPROM memory, and non-volatile RAM (NVRAM) memory. The above data storage unit types are exemplary only, and are thus not limiting as to the types of memory usable for storage of a computer program.

(43) FIG. **8** illustrates a top view of an external structure **102** having thermal emitters **104**,

according to an example of the present disclosure. FIG. 9 illustrates a top view of an external structure 102 having thermal emitters 104, according to an example of the present disclosure. Referring to FIGS. 8 and 9, the external structure 102 can be a wing 116.

(44) In at least one example, the thermal emitters 104 can be formed of a metal matrix composite secured to the wing 116. The thermal emitters 104 remain attached to the surface while strain is induced in or experienced by the wing 116 after flexing. In at least one example, the thermal emitters 104 can include a plurality of non-flexible cells 104a or 104b connected together in a tessellated pattern 200 of shapes, such as hexagons, octagons, bow-tie shapes, various other polygonal shapes, and/or the like that allow for flexibility therebetween along multiple axes. The tessellated pattern or geometry 200 absorbs movement and allows the metal matrix component material to flex with the wing 116 as strain is induced, and remain attached to the surface of the wing 116 from the wing root 116a to the wing tip 116b. Tessellated patterns 200 allow flexing, and may have geometries with a negative Poisson's ratio (also referred to as auxetic materials). Poisson's ratio defines how a material expands or contracts transversely under longitudinal compression. A positive Poisson's ratio intuitively posits that a material will or must expand in the orthogonal direction when compressed. A negative Poisson's ratio means that a material will contract under tension or expand under pressure. The maximum spacing and distance on the tessellated shapes can remain the same across the entire surface of the external structure 102, with a larger number of rows of shapes near the wider area of the wing root 116a (for example, 10 rows). The number of rows of shapes can decrease as the width narrows toward the wing tip 116b.

(45) FIG. 10 illustrates a flow chart of a deicing method, according to an example of the present disclosure. Referring to FIGS. 1-10, the method includes integrating 200 one or more thermal emitters 104 with one or more of external structures 102 of an aircraft 100; providing 202 electrical power to the one or more thermal emitters 104 by one or more of an auxiliary power unit 106a of the aircraft 100, a power distribution system 106b of the aircraft 100, one or more engines 106d of the aircraft 100, or an external power cart 106c that is separate and distinct from the aircraft 100; and generating 204 heat, by the one or more thermal emitters 104, to deice the one or more external structures 102.

(46) In at least one example, said integrating 200 includes integrating the one or more thermal emitters 104 with all of the external structures 102. In at least one example, said integrating 200 includes mounting the one or more thermal emitters 104 to one or more exterior surfaces of the one or more external structures 102. In at least one example, said integrating 200 includes covering less than an entirety of the one or more external structures 102 with the one or more thermal emitters 104.

(47) In at least one example, the method also includes providing, by the one or more thermal emitters 104, electromagnetic effect protection to the one or more external structures 102 without a separate current carrying path.

(48) In at least one example, the method also includes determining, by a control unit 150, a configuration for the one or more thermal emitters 104 based on a unit area 140 that is representative of a portion of the one or more external structures 102. The method can also include generating, by the control unit 150, a one dimensional thermal resistance model to determine a temperature of an exposed outer mold line patch of the aircraft 100.

(49) In at least one example, said integrating includes tessellating a plurality of cells together.

(50) Further, the disclosure comprises examples according to the following clauses:

(51) Clause 1. An aircraft comprising: external structures; and one or more thermal emitters integrated with one or more of the external structures, wherein the one or more thermal emitters are configured to generate heat to deice the one or more external structures, and wherein the one or more thermal emitters are configured to receive electrical power from one or more of an auxiliary power unit of the aircraft, a power distribution system of the aircraft, one or more engines of the aircraft, or an external power cart that is separate and distinct from the aircraft.

(52) Clause 2. The aircraft of Clause 1, wherein the external structures comprise one or more of a fuselage, one or more wings, an empennage, a vertical stabilizer, a horizontal stabilizer, or control surfaces.

(53) Clause 3. The aircraft of Clauses 1 or 2, wherein the one or more thermal emitters are integrated with all of the external structures.

(54) Clause 4. The aircraft of any of Clauses 1-3, wherein the one or more thermal emitters are mounted to one or more exterior surfaces of the one or more external structures.

(55) Clause 5. The aircraft of any of Clauses 1-4, wherein the one or more thermal emitters are embedded within the one or more external structures.

(56) Clause 6. The aircraft of any of Clauses 1-5, wherein the one or more thermal emitters are formed of a metal matrix composite.

(57) Clause 7. The aircraft of any of Clauses 1-6, wherein the one or more thermal emitters comprise one or more of wires, ribbons, tape, or strips.

(58) Clause 8. The aircraft of any of Clauses 1-7, wherein the one or more thermal emitters cover less than an entirety of the one or more external structures.

(59) Clause 9. The aircraft of any of Clauses 1-8, wherein the one or more thermal emitters comprise a plurality of segments spaced apart from one another in relation to the one or more external structures.

(60) Clause 10. The aircraft of any of Clauses 1-9, wherein the one or more thermal emitters comprise a grid having a plurality of segments separated by open areas.

(61) Clause 11. The aircraft of any of Clauses 1-10, wherein the one or more thermal emitters further provide electromagnetic effect protection to the one or more external structures without a separate current carrying path.

(62) Clause 12. The aircraft of any of Clauses 1-11, wherein a control unit is configured to determine a configuration for the one or more thermal emitters based on a unit area that is representative of a portion of the one or more external structures.

(63) Clause 13. The aircraft of Clause 12, wherein the control unit is configured to generate a one dimensional thermal resistance model to determine a temperature of an exposed outer mold line patch of the aircraft.

(64) Clause 14. The aircraft of any of Clauses 1-13, wherein the one or more thermal emitters comprise a plurality of cells connected together in a tessellated pattern.

(65) Clause 15. A method comprising: integrating one or more thermal emitters with one or more of external structures of an aircraft; providing electrical power to the one or more thermal emitters by one or more of an auxiliary power unit of the aircraft, a power distribution system of the aircraft, one or more engines of the aircraft, or an external power cart that is separate and distinct from the aircraft; and generating heat, by the one or more thermal emitters, to deice the one or more external structures.

(66) Clause 16. The method of Clause 15, wherein said integrating comprises integrating the one or more thermal emitters with all of the external structures.

(67) Clause 17. The method of Clauses 15 or 16, wherein said integrating comprises mounting the one or more thermal emitters to one or more exterior surfaces of the one or more external structures.

(68) Clause 18. The method of any of Clauses 15-17, wherein said integrating comprises covering less than an entirety of the one or more external structures with the one or more thermal emitters.

(69) Clause 19. The method of any of Clauses 15-18, further comprising providing, by the one or more thermal emitters, electromagnetic effect protection to the one or more external structures without a separate current carrying path.

(70) Clause 20. The method of an of Clauses 15-19, further comprising determining, by a control unit, a configuration for the one or more thermal emitters based on a unit area that is representative of a portion of the one or more external structures.

(71) Clause 21. The method of Clause 20, further comprising generating, by the control unit, a one dimensional thermal resistance model to determine a temperature of an exposed outer mold line patch of the aircraft.

(72) Clause 22. The method of any of Clauses 15-20, wherein said integrating comprises tessellating a plurality of cells of the one or more thermal emitters connected together.

(73) Clause 23. An aircraft comprising: external structures including one or more of a fuselage, one or more wings, an empennage, a vertical stabilizer, a horizontal stabilizer, or control surfaces; and one or more thermal emitters integrated with all of the external structures, wherein the one or more thermal emitters cover less than an entirety of the external structures, wherein the one or more thermal emitters comprise a grid having a plurality of segments separated by open areas, wherein the one or more thermal emitters are configured to generate heat to deice the one or more external structures, and wherein the one or more thermal emitters are configured to receive electrical power from one or more of an auxiliary power unit of the aircraft, a power distribution system of the aircraft, one or more engines of the aircraft, or an external power cart that is separate and distinct from the aircraft, wherein the one or more thermal emitters further provide electromagnetic effect protection to the external structures without a separate current carrying path, wherein a control unit is configured to determine a configuration for the one or more thermal emitters based on a unit area that is representative of a portion of the one or more external structures, and wherein the control unit is configured to generate a one dimensional thermal resistance model to determine a temperature of an exposed outer mold line patch of the aircraft.

(74) As described herein, examples of the present disclosure provide improved systems and methods for deicing surfaces of an aircraft. Further, examples of the present disclosure provide effective and efficient systems and methods for deicing surfaces of an aircraft. Also, examples of the present disclosure provide cost-effective and environmentally friendly systems and methods for deicing surfaces of an aircraft.

(75) While various spatial and directional terms, such as top, bottom, lower, mid, lateral, horizontal, vertical, front and the like can be used to describe examples of the present disclosure, it is understood that such terms are merely used with respect to the orientations shown in the drawings. The orientations can be inverted, rotated, or otherwise changed, such that an upper portion is a lower portion, and vice versa, horizontal becomes vertical, and the like.

(76) As used herein, a structure, limitation, or element that is “configured to” perform a task or operation is particularly structurally formed, constructed, or adapted in a manner corresponding to the task or operation. For purposes of clarity and the avoidance of doubt, an object that is merely capable of being modified to perform the task or operation is not “configured to” perform the task or operation as used herein.

(77) It is to be understood that the above description is intended to be illustrative, and not restrictive. For example, the above-described examples (and/or aspects thereof) can be used in combination with each other. In addition, many modifications can be made to adapt a particular situation or material to the teachings of the various examples of the disclosure without departing from their scope. While the dimensions and types of materials described herein are intended to define the aspects of the various examples of the disclosure, the examples are by no means limiting and are exemplary examples. Many other examples will be apparent to those of skill in the art upon reviewing the above description. The scope of the various examples of the disclosure should, therefore, be determined with reference to the appended claims, along with the full scope of equivalents to which such claims are entitled. In the appended claims and the detailed description herein, the terms “including” and “in which” are used as the plain-English equivalents of the respective terms “comprising” and “wherein.” Moreover, the terms “first,” “second,” and “third,” etc. are used merely as labels, and are not intended to impose numerical requirements on their objects. Further, the limitations of the following claims are not written in means-plus-function format and are not intended to be interpreted based on 35 U.S.C. § 112(f), unless and until such

claim limitations expressly use the phrase “means for” followed by a statement of function void of further structure.

(78) This written description uses examples to disclose the various examples of the disclosure, including the best mode, and also to enable any person skilled in the art to practice the various examples of the disclosure, including making and using any devices or systems and performing any incorporated methods. The patentable scope of the various examples of the disclosure is defined by the claims, and can include other examples that occur to those skilled in the art. Such other examples are intended to be within the scope of the claims if the examples have structural elements that do not differ from the literal language of the claims, or if the examples include equivalent structural elements with insubstantial differences from the literal language of the claims.

## Claims

1. An aircraft comprising: external structures; and thermal emitters integrated with the external structures, wherein the thermal emitters are configured to generate heat to deice the external structures, and wherein the thermal emitters are configured to receive electrical power from one or more sources, a control unit, wherein the control unit determines a configuration for the thermal emitters by creating a unit area that is representative of a portion of the external structures, wherein the unit area has a width and an exposed length in relation to an outer mold line of the external structures, and wherein the control unit generates a one dimensional thermal resistance model to determine a temperature of an exposed outer mold line patch of the external structures, and wherein the unit area includes the thermal emitters including a plurality of segments over the portion of the external structures and the control unit determines a spacing between the plurality of segments so that the thermal emitters provide sufficient deicing heat to the portion of the external structures.
2. The aircraft of claim 1, wherein the one or more sources comprise an auxiliary power unit of the aircraft, a power distribution system of the aircraft, one or more engines of the aircraft, and an external power cart that is separate and distinct from the aircraft.
3. The aircraft of claim 1, wherein the external structures comprise one or more of a fuselage, one or more wings, an empennage, a vertical stabilizer, a horizontal stabilizer, or control surfaces.
4. The aircraft of claim 1, wherein the thermal emitters are integrated with all of the external structures.
5. The aircraft of claim 1, wherein the thermal emitters are mounted to exterior surfaces of the external structures.
6. The aircraft of claim 1, wherein the thermal emitters are embedded within the external structures.
7. The aircraft of claim 1, wherein the thermal emitters are formed of a metal matrix composite.
8. The aircraft of claim 1, wherein the thermal emitters comprise one or more of wires, ribbons, tape, or strips.
9. The aircraft of claim 1, wherein the thermal emitters cover less than an entirety of the external structures.
10. The aircraft of claim 1, wherein the thermal emitters comprise the plurality of segments spaced apart from one another in relation to the external structures.
11. The aircraft of claim 1, wherein the thermal emitters comprise a grid having the plurality of segments separated by open areas.
12. The aircraft of claim 1, wherein the thermal emitters further provide electromagnetic effect protection to the external structures without a separate current carrying path.
13. The aircraft of claim 1, wherein the thermal emitters comprise a plurality of cells connected together in a tessellated pattern.
14. The aircraft of claim 1, wherein the control unit is further configured to determine an amount of heat to apply for deicing in relation to the unit area, which the control unit uses to determine the configuration in relation to an entirety of the external structures.

15. The aircraft of claim 1, wherein the control unit is configured to determine the configuration based on a maximum service temperature, dimensions of the external structures, a minimum deicing time, a maximum deicing time, and required electrical power.

16. The aircraft of claim 1, wherein the control unit is configured to determine the configuration by referencing a predetermined heat necessary to create a layer of water under a stack of snow and ice.

17. A method comprising: integrating thermal emitters with external structures of an aircraft; determining, by a control unit, a configuration for the thermal emitters by creating a unit area that is representative of a portion of the external structures, wherein the unit area has a width and an exposed length in relation to an outer mold line of the external structures, and wherein the unit area includes the thermal emitters including a plurality of segments over the portion of the external structures; determining, by the control unit, a spacing between the plurality of segments so that the thermal emitters provide sufficient deicing heat to the portion of the external structures; generating, by the control unit, a one dimensional thermal resistance model to determine a temperature of an exposed outer mold line patch of the external structures; and generating heat, by the thermal emitters, to deice the external structures.

18. The method of claim 17, wherein said integrating comprises integrating the thermal emitters with all of the external structures.

19. The method of claim 17, wherein said integrating comprises mounting the thermal emitters to one or more exterior surfaces of the external structures.

20. The method of claim 17, wherein said integrating comprises covering less than an entirety of the external structures with the thermal emitters.

21. The method of claim 17, further comprising providing, by the thermal emitters, electromagnetic effect protection to the external structures without a separate current carrying path.

22. The method of claim 17, wherein said integrating comprises tessellating a plurality of cells of the thermal emitters connected together.

23. The method of claim 17, further comprising: determining, by the control unit, an amount of heat to apply for deicing in relation to the unit area, which the control unit uses to determine the configuration for the thermal emitters in relation to an entirety of the external surfaces, wherein said determining, by the control unit, the configuration for the thermal emitters is based on a maximum service temperature, dimensions of the external structures, a minimum deicing time, a maximum deicing time, and required electrical power, and wherein said determining, by the control unit, the configuration further comprises referencing a predetermined heat necessary to create a layer of water under a stack of snow and ice.

24. An aircraft comprising: external structures including one or more of a fuselage, one or more wings, an empennage, a vertical stabilizer, a horizontal stabilizer, or control surfaces; and thermal emitters integrated with all of the external structures, wherein the thermal emitters cover less than an entirety of the external structures, wherein the thermal emitters comprise a grid having a plurality of segments separated by open areas, wherein the thermal emitters are configured to generate heat to deice the external structures, and wherein the thermal emitters are configured to receive electrical power from one or more of an auxiliary power unit of the aircraft, a power distribution system of the aircraft, one or more engines of the aircraft, or an external power cart that is separate and distinct from the aircraft, wherein the thermal emitters further provide electromagnetic effect protection to the external structures without a separate current carrying path, a control unit, wherein the control unit determines a configuration for the thermal emitters by creating a unit area that is representative of a portion of the external structures, wherein the unit area has a width and an exposed length in relation to an outer mold line of the external structures, and wherein the control unit generates a one dimensional thermal resistance model to determine a temperature of an exposed outer mold line patch of the external structures, and wherein the unit area includes the thermal emitters including the plurality of segments over a portion of the external

structures and the control unit determines a spacing between the plurality of segments so that the thermal emitters provide sufficient deicing heat to the portions of the external structures.

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